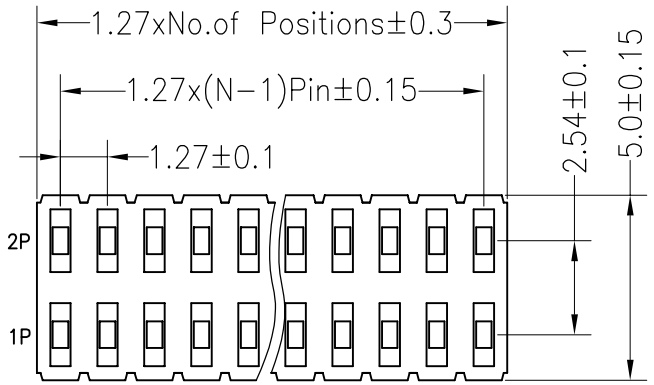
HSF RoHS

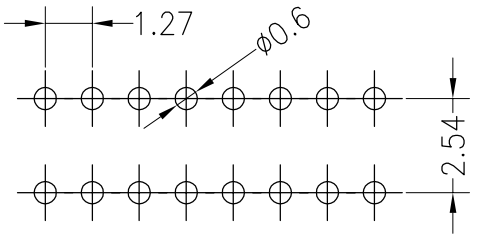
FILE NO :E362810

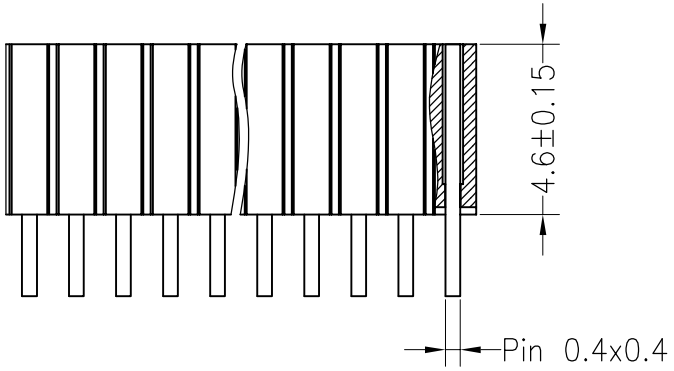
SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°c to +105°c

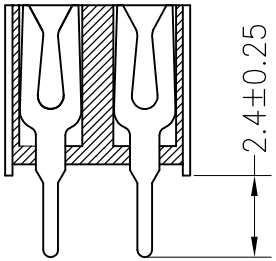
Contact Material:Brass
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

2546 02 XX X N XX S Y X 01

- 02XX — No.of Pins 2*2~2*50
- X — Insulator Material Option
  A=BK-PBT
  C=BK-PA6T
  D=BK-PA46
  E=BK-PA9T
  F=BK-LCP
- XX — Contact Plating
  G0:Gold Flash
  G1:3U" Gold
  G2:5U" Gold
  G3:10U" Gold
  G4:15U" Gold
  G5:30U" Gold
  S0:Gold Flash/Tin
  SN:Tin
- X — Packing
  0=PE Bag
  T=Tube
  P=Tube+Cap
  R=Reel+Cap
  M=Reel+Mylar

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2015.01.18	NEW DRAWING	

OPERATION		DRAW	Liu Miao	15.01.18	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	254602XXXNXXSYX01
TITLE:	1.27*2.54PF H4.6mm 2xNpin 180°